

ECX-33Q SMD CRYSTAL

Request a Sample

OPERATING CONDITIONS / ELECTRICAL CHARACTERISTICS

MIN

12.000

6

-55

-55

ECX-33Q

20

MAX

40.000

± 30

± 100

7

Series

100

+125

+125

±5

TYP

CONDITIONS

Fundamental

@ +25°C

-55 ~ +125°C

(DU Option)

Co

Specify in P/N

DL

Topr

(DU Option)

Tstg

@ +25°C ±3°C



UNITS

MHz

ppm

ppm

рF

pF

 μW

°C

°C

ppm

Rev.2018

The ECX-33Q is a miniature SMD Crystal with a 3.2 x 2.5 mm footprint. AEC-Q200 Qualified.

ECX-33Q SMD CRYSTAL



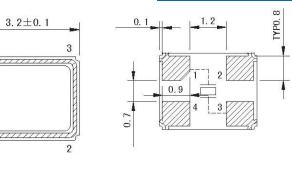
Low Profile

 2.5 ± 0.1

0.8 MAX

- 3.2 x 2.5 mm Footprint
- RoHS Compliant
- AEC-Q200 Qualified

DIMENSIONS (mm)



Pad Connections						
1	In/Out					
2	Gnd					
3	Out/In					
4	Gnd					

Frequency (MHz)	ESR Ω Max.
12.000 ~ 15.999	100
16.000 ~ 19.999	80
20.000 ~ 23.999	60
24 000 ~ 40 000	40

← 2.3 **→**

► 1.3 **◄**1.0 **►** 1.3 **◄**

Figure 2) Suggested land

Figure	1)	Тор,	Side,	and	Bottom

Crystal is symmetrical, pad 1 & 3 are interchangeable. Chamfer on the bottom pad has no electrical significance.

PART NUMBERING GUIDE: Example ECS-200-20-330-DU-TR

PARAMETERS

Mode of Oscillation

Frequency Tolerance*

Frequency Stability*

Shunt Capacitance

Load Capacitance

Operating Temperature*

Storage Temperature

Aging (First Year)

Drive Level

Frequency

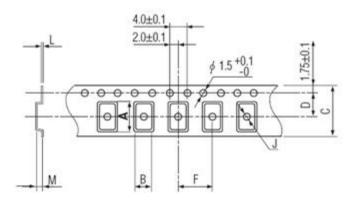
ECS - FRI	EQUENCY ABBREVIATION	LOAD	PACKA	GE	AVAILABLE OPT	TONS	PACKAGING
		CAPACITANCE		Tolerance	e Stability	Temp Range	
ECS	200 = 20.000 MHz See P/N Guide	20 = 20 pF 10 = 10 pF S = Series	33Q = ECX-33Q	Blank = ±30 ppm A = ± 25 ppm J = ± 20 ppm R = ± 15 ppm C = ± 10 ppm	D= ±100 ppm E = ± 50 ppm G = ± 30 ppm H = ± 25 ppm	L = -10 ~ +70°C M = -20 ~ +70°C Y = -30 ~ +85°C N = -40 ~ +85°C	Tape & Reel
. ,	ailable options in P/N.	od tomp rango		C _ 10 ppiii	T = ± 20 ppm † W = ±15 ppm † K = ± 10 ppm †	P = -40 ~ +105°C S = -40 ~ +125°C U = -55 ~ +125°C	

[†] Contact ECS for availability over extended temp range.



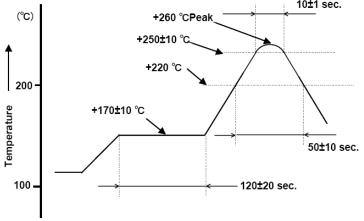


POCKET TAPE DIMENSIONS (mm)



Α	В	С	D	F	J	L	М	Reel Dia.	Qty/Reel
3.5	2.8	8.0	3.5	4.0	1.1	0.25	1.0	180	1K JES 3K

SOLDER PROFILE			
Peak solder Temp +260°C Max 10 sec Max.			
2 Cycles Max.			
MSL 1, Lead Finish Au			



		0±1 sec.
C)	+260 °CPeak	_
	+250±10 ℃	
	+220 °C	
00 -		\
	+170±10 °C	
		50±10 sec.
00 –	——————————————————————————————————————	

Figure 1) Suggested Reflow Profile

DEVELOPED FREQUENCIES					
Abbreviation	Frequency (MHZ)				
120	12.000				
122.8	12.288				
130	13.000				
135.6	13.560				
143	14.31818				
147.4	14.7456				
160	16.000				
163.8	16.384				
184	18.432				
196.6	19.6608				
200	20.000				
221	22.1184				
240	24.000				
245.7	24.576				
250	25.000				
260	26.000				
270	27.000				
286.3	28.63636				
300	30.000				
320	32.000				
330	33.000				
400	40.000				